

1337010

https://www.phoenixcontact.com/us/products/1337010

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SMD female connector, nominal current: 2.2 A, Test voltage: 500 V AC, number of positions: 12, pitch: 1.27 mm, color: black, contact surface: Au, contact connection type: Socket, mounting: SMD soldering



Your advantages

- The first high-speed data transmission at up to 28 Gbps using the established market standard, opens up new design possibilities.
- · Robust 6-pos. to 100-pos. board-to-board and wire-to-board connectors ensure greater flexibility with regard to component options.
- · Time savings during the development process with customer-specific simulations for data integrity
- · Gold-plated contact points enable long-term stable signal transmission and currents of up to 2.3 A.
- Design-in support during device development using MCAD/ECAD data and a free sample service

Commercial data

Item number	1337010
Packing unit	560 pc
Minimum order quantity	560 pc
Sales key	AA24
Product key	AAXAAA
GTIN	4063151638511
Weight per piece (including packing)	1.25 g
Weight per piece (excluding packing)	1.25 g
Customs tariff number	85366930
Country of origin	CN



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Technical data

Product properties

Product type	SMD female connector
Product family	FR 1,27/FH
Number of positions	12
Pitch	1.27 mm
Number of rows	2
Pin layout	Linear pad geometry
Data management status	
Data management status	
Article revision	01

Article revision	U

Electrical properties

Nominal current I _N	2.2 A IEC 60512-5-2:2002-02 (at 20°C 100-pos.)
Contact resistance	10 mΩ
Test voltage	500 V AC IEC 60512-4-1:2003

Mounting

Mounting type	SMD soldering
Pin layout	Linear pad geometry

Processing notes

Process	Reflow soldering
Moisture Sensitive Level	MSL 1
Classification temperature T _c	260 °C
Solder cycles in the reflow	3

Material specifications

Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	Selective coating
Metal surface contact area (top layer)	Gold (Au)
Metal surface contact area (middle layer)	Nickel (Ni)
Metal surface soldering area (top layer)	Tin (Sn)
Metal surface soldering area (middle layer)	Nickel (Ni)

Material data - housing

Matchar data Hodoling	
Color (Housing)	black (9005)
Insulating material	LCP
Insulating material group	IIIb
CTI according to IEC 60112	150
Flammability rating according to UL 94	V0



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Notes

Notes on operation	The permissible voltage during operation depends on the application, taking into consideration the air clearances and creepage distances within the scope of insulation requirements in accordance with IEC 60664-1.
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Dimensions

Dimensional drawing	P
Pitch	1.27 mm
Width [w]	12.71 mm
Height [h]	4.53 mm
Length [I]	10.8 mm
Installed height	3.78 mm
Application	

Application

Contact cover	0.9 mm
Center offset	± 0.7 mm in longitudinal and transverse direction
Wipe length	1.5 mm
Angular tolerance	± 5 ° in longitudinal and transverse direction

PCB design

	-	
Pad geometry 0.8 x 0.8 mm	Pad geometry	0.8 x 0.8 mm

Electrical tests

Thermal test | Test group C

Specification	IEC 60512-5-2:2002-02
Insulation resistance	
Specification	IEC 60512-3-1:2002-02
Insulation resistance, neighboring positions	≥ 5 GΩ
Air clearances and creepage distances	
Insulating material group	IIIb
Minimum value for clearance and creepage distance	0.4 mm

Environmental and real-life conditions

Vibration test

Specification	IEC 60068-2-6:2007-12
Frequency	10 - 2000 - 10 Hz
Sweep speed	1 octave/min



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Amplitude	1.5 mm (10 Hz 58 Hz)
Acceleration	200 m/s² (58 Hz 2000 Hz)
Test duration per axis	2.5 h
Test directions	X-, Y- and Z-axis
Durability test	
Specification	IEC 60512-9-1:2010-03 (following)
Contact resistance R ₁	10 mΩ
Contact resistance R ₂	15 mΩ
Insertion/withdrawal cycles	500
Insulation resistance, neighboring positions	≥ 5 GΩ
Shocks	
Specification	IEC 60068-2-27:2008-02
Pulse shape	Semi-sinusoidal
Acceleration	490 m/s²
Shock duration	11 ms
Test directions	X-, Y- and Z-axis (pos. and neg.)
Ambient conditions	
Ambient temperature (operation)	-55 °C 125 °C
Ambient temperature (storage/transport)	-40 °C 70 °C
Relative humidity (storage/transport)	30 % 70 %
Ambient temperature (assembly)	-5 °C 100 °C

Packaging specifications

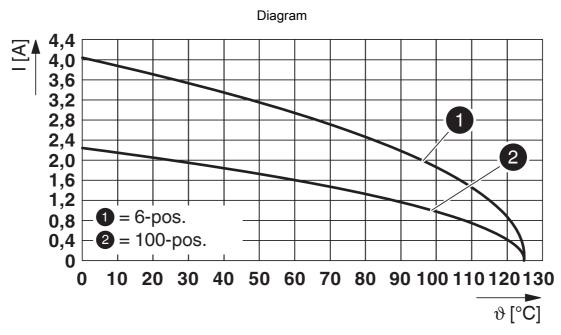
Dimensional drawing	
Type of packaging	24 mm wide tape
[W] tape width	24 mm
[W2] coil overall dimension	30.4 mm
[A] coil diameter	330 mm
Outer packaging type	Transparent-Bag
ESD level	(D) electrostatically conductive
Specification	DIN EN 61340-5-1 (VDE 0300-5-1): 2008-07



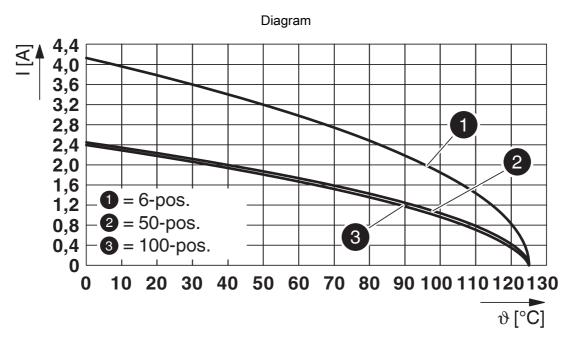
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Drawings



Type: FR 1,27/...-FH with FR 1,27/...-MH



Type: FR 1,27/...-FH with FR 1,27/...-MV 3,25



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Approvals

To download certificates, visit the product detail page: https://www.phoenixcontact.com/us/products/1337010

.91	cUL Recognized Approval ID: E118976-20230317			
	Nominal voltage U_N	Nominal current I _N	Cross section AWG	Cross section mm ²
	29.9 V	1.4 A	-	-

71	UL Recognized Approval ID: E118976-20	0230317			
		Nominal voltage U_N	Nominal current I _N	Cross section AWG	Cross section mm ²
		29.9 V	2 A	-	-

cULus Recognized



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Classifications

ECLASS

ECLASS-11.0	27460201
ECLASS-12.0	27460201
ECLASS-13.0	27460201

ETIM

ETIM 9.0	EC002637	



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Environmental product compliance

EU RoHS

otions
substances above the limits
above 0.1 wt%
: 6

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